

Fullwin Technology



FWE08N130RH

Single N-channel Trench MOSFET 80V

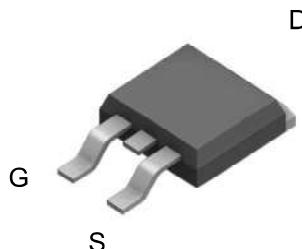
FWE08N130 Single N-Channel Trench MOSFET 80V

General Description

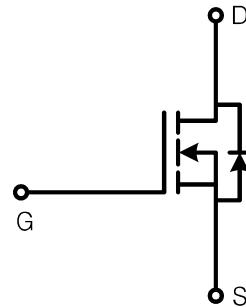
The FWE08N130RH uses advanced Fullwin's MOSFET Technology, which provides high performance in on-state resistance, fast switching performance and excellent quality. These devices can also be utilized in industrial applications such as Low Power Drives of E-bike (E-Vehicles), DC/DC converter, and general purpose applications.

Features

- $V_{DS} = 80V$
- $I_D = 120 A @ V_{GS} = 10V$
- $R_{DS(ON)} < 5.0 \text{ m}\Omega @ V_{GS} = 10V$
- 175 °C operating temperature
- 100% UIL Tested
- 100% R_g Tested
- 100% ΔV_{DS} Tested



TO-263



Absolute Maximum Ratings ($T_J = 25^\circ\text{C}$)

Characteristics	Symbol	Rating	Unit
Drain-Source Voltage	V_{DSS}	80	V
Gate-Source Voltage	V_{GSS}	± 20	V
Continuous Drain Current ⁽¹⁾	I_D	132	A
		120	
		93	
		14.9	
Pulsed Drain Current ⁽²⁾	I_{DM}	480	
Power Dissipation	P_D	188	W
		94	
		2.4	
Single Pulse Avalanche Energy ⁽³⁾	E_{AS}	200	mJ
Junction and Storage Temperature Range	T_J, T_{stg}	-55~175	°C

Thermal Characteristics

Characteristics	Symbol	Rating	Unit
Thermal Resistance, Junction-to-Ambient ⁽¹⁾	R_{JA}	62.5	°C/W
Thermal Resistance, Junction-to-Case	R_{JC}	0.8	

Ordering Information

Part Number	Temp. Range	Package	Packing	RoHS Status
FWE08N130RH	-55~175°C	TO-263	Reel	Halogen Free

Electrical Characteristics ($T_J = 25^\circ\text{C}$)

Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Static Characteristics						
Drain-Source Breakdown Voltage	BV_{DSS}	$I_D = 250\mu\text{A}, V_{GS} = 0\text{V}$	80	-	-	V
Gate Threshold Voltage	$V_{GS(\text{th})}$	$V_{DS} = V_{GS}, I_D = 250\mu\text{A}$	2.4		3.8	
Drain Cut-Off Current	$I_{\text{DS}}^{\text{off}}$	$V_{DS} = 80\text{V}, V_{GS} = 0\text{V}$	-	-	1.0	μA
Gate Leakage Current	I_{GS}	$V_{GS} = \pm 20\text{V}, V_{DS} = 0\text{V}$	-	-	± 100	nA
Drain-Source ON Resistance	$R_{DS(\text{ON})}$	$V_{GS} = 10\text{V}, I_D = 50\text{A}$		4.0	5.0	$\text{m}\Omega$
Forward Transconductance	g_f	$V_{DS} = 10\text{V}, I_D = 50\text{A}$	-	81	-	S
Dynamic Characteristics						
Total Gate Charge	$Q_{g(10\text{V})}$	$V_{DD} = 40\text{V}, I_D = 50\text{A}, V_{GS} = 10\text{V}$	-	61	-	nC
Gate-Source Charge	Q_{gs}		-	18	-	
Gate-Drain Charge	Q_{gd}		-	15	-	
Input Capacitance	C_{iss}	$V_{DS} = 40\text{V}, V_{GS} = 0\text{V}, f = 1.0\text{MHz}$	-	4150	-	pF
Reverse Transfer Capacitance	C_{rss}		-	40	-	
Output Capacitance	C_{oss}		-	970	-	
Turn-On Delay Time	$t_{d(on)}$	$V_{GS} = 10\text{V}, V_{DD} = 40\text{V}, I_D = 50\text{A}, R_G = 3\Omega$	-	24	-	ns
Rise Time	t_r		-	13	-	
Turn-Off Delay Time	$t_{d(off)}$		-	43	-	
Fall Time	t_f		-	14	-	
Gate Resistance	R_g	$f=1.0\text{ MHz}$	-	2.5	-	Ω
Drain-Source Body Diode Characteristics						
Source-Drain Diode Forward Voltage	V_{SD}	$I_S = 50\text{A}, V_{GS} = 0\text{V}$	-	0.9	1.2	V
Body Diode Reverse Recovery Time	t_{rr}	$I_F = 50\text{A}, dI/dt = 100\text{A}/\mu\text{s}$	-	86	-	ns
Body Diode Reverse Recovery Charge	Q_{rr}		-	270	-	nC

- Note : 1. Surface mounted FR-4 board by JEDEC (jesd51-7)
 2. Pulse width limited by $T_{j,\text{max}}$
 3. E_{AS} is tested at starting $T_j = 25^\circ\text{C}$, $L = 1.0\text{mH}$, $I_{AS} = 20\text{ A}$, $V_{DD} = 50\text{V}$, $V_{GS} = 10\text{V}$

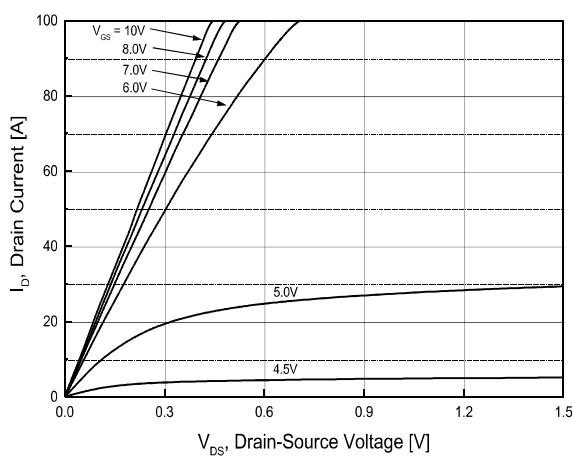


Fig.1 On-Region Characteristics

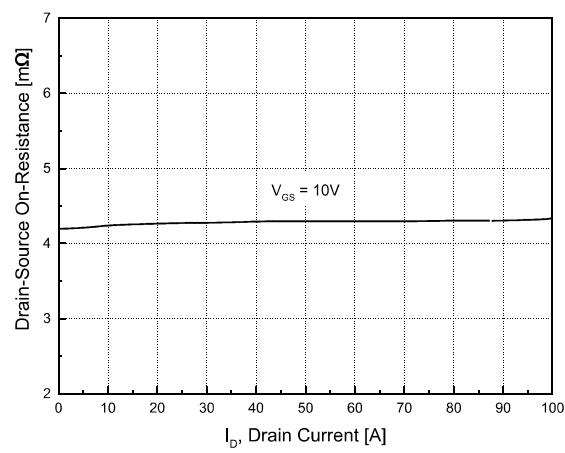


Fig.2 On-Resistance Variation with Drain Current and Gate Voltage

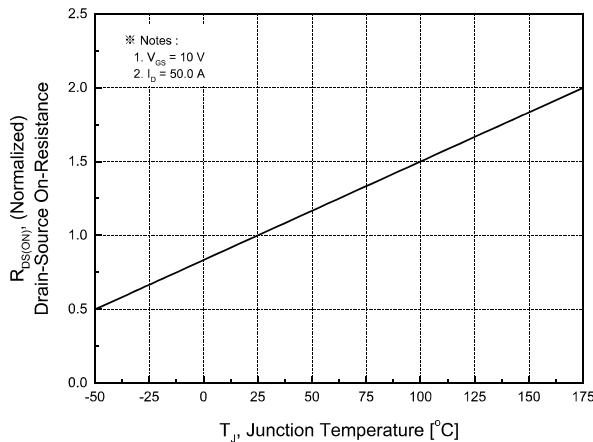


Fig.3 On-Resistance Variation with Temperature

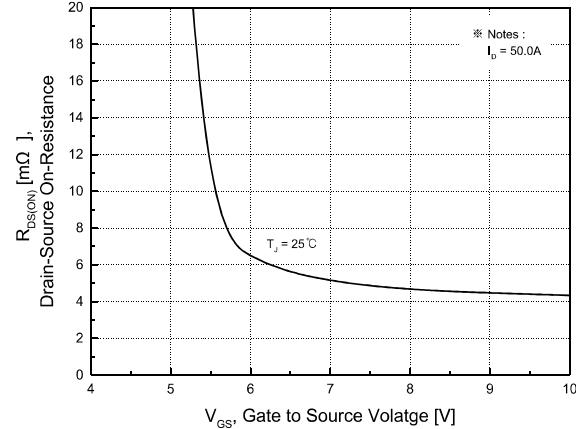


Fig.4 On-Resistance Variation with Gate to Source Voltage

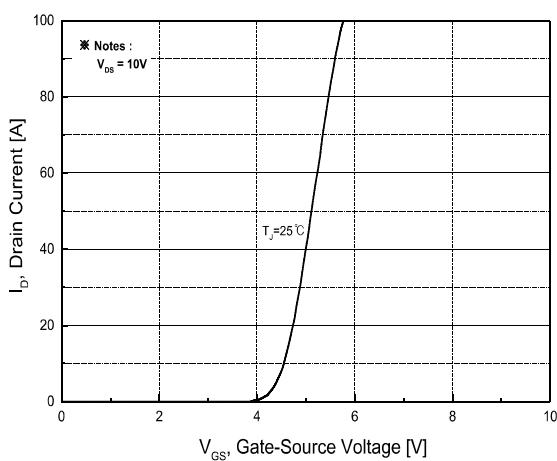


Fig.5 Transfer Characteristics

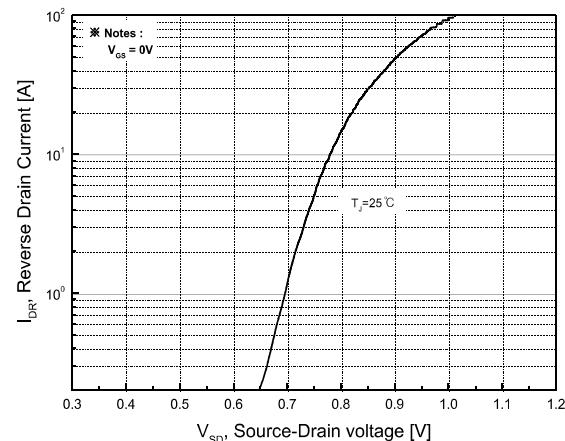


Fig.6 Body Diode Forward Voltage Variation with Source Current and Temperature

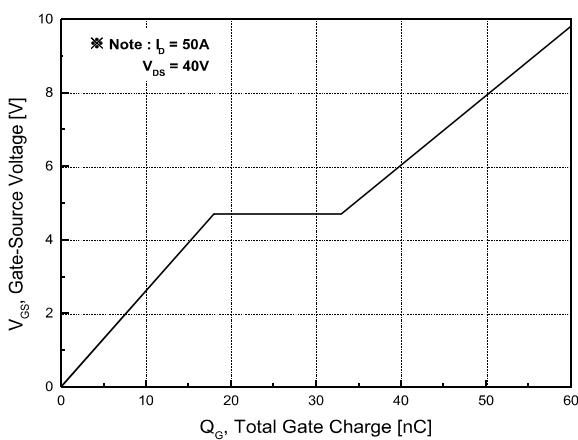


Fig.7 Gate Charge Characteristics

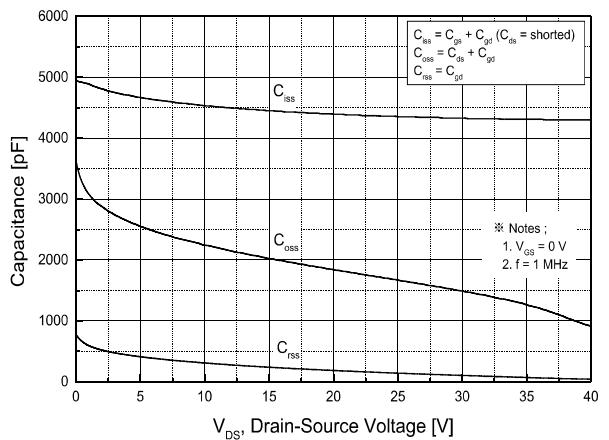


Fig.8 Capacitance Characteristics

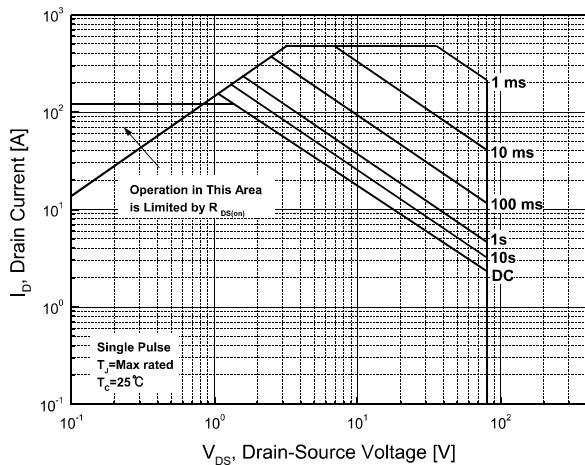


Fig.9 Maximum Safe Operating Area

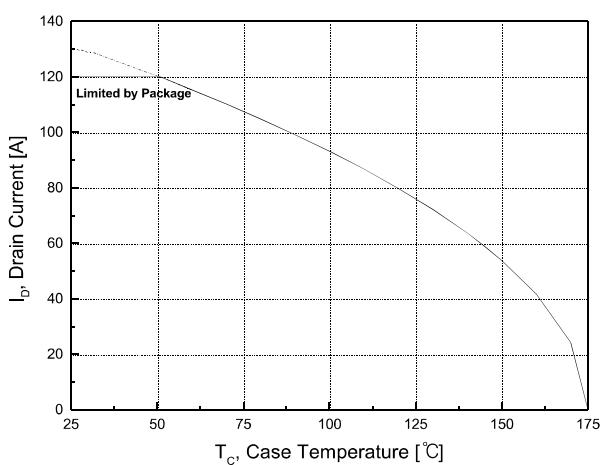


Fig.10 Maximum Drain Current vs. Case Temperature

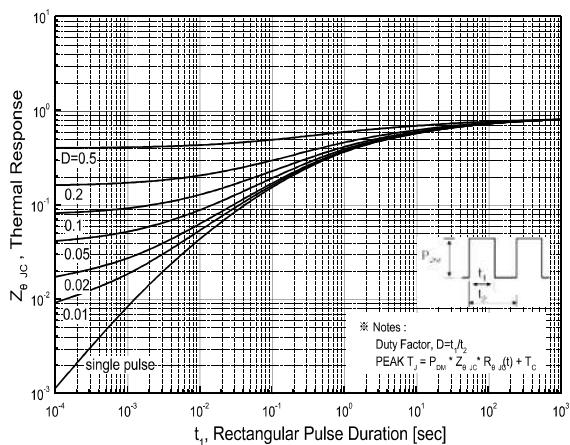
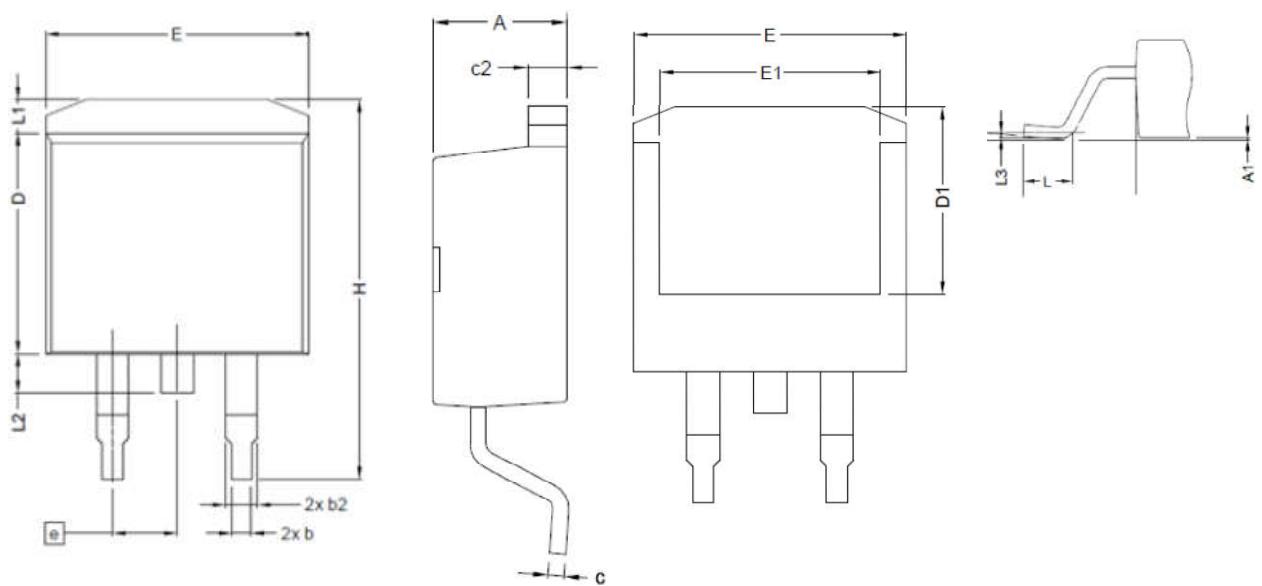


Fig.11 Transient Thermal Response Curve

Package Dimension

TO-263

Dimensions are in millimeters, unless otherwise specified



Symbol	Millimeters(mm)	
	Min	Max
A	4.064	4.675
A1	-	0.254
b	0.508	0.99
b2	1.140	1.778
c	0.310	0.736
c2	1.140	1.650
D	8.382	9.652
D1	6.6	-
E	9.652	10.668
E1	6.223	-
e	BSC 2.54	
H	14.605	15.875
L	1.778	2.794
L1	-	1.676
L2	-	1.778
L3	BSC 0.254	

DISCLAIMER:

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